SN54180, SN74180 9-BIT ODD/EVEN PARITY GENERATORS/CHECKERS

DECEMBER 1972-REVISED MARCH 1988

FUNCTION TABLE

INP	OUTPUTS								
Σ OF H's AT	EVEN	CDD	Σ	Σ					
A THRU H	EVEN	טטט	EVEN	ODD					
EVEN	Τ	L	Н	L					
ODD	Н	L	L	Н					
EVEN	L	н	L	Н					
ODD	L	Н	Н	L					
×	Н	H	L	٦					
×	L	L	Н	Н					

H = high level, L = low level, X = irrelevant

SN54180 . . . J OR W PACKAGE

description

These universal, monolithic, 9-bit (8 data bits plus 1 parity bit) parity generators/checkers, utilize familiar Series 54/74 TTL circuitry and feature odd/even outputs and control inputs to facilitate operation in either odd or even-parity applications. Depending on whether even or odd parity is being generated or checked, the even or odd inputs can be utilized as the parity or 9th-bit input. The word-length capability is easily expanded by cascading.

The SN54180/SN74180 are fully compatible with other TTL or DTL circuits. Input buffers are provided so that each data input represents only one normalized series 54/74 load. A full fan-out to 10 normalized series 54/74 loads is available from each of the outputs at a low logic level. A fan-out to 20 normalized loads is provided at a high logic level to facilitate the connection of unused inputs to used inputs. Typical power dissipation is 170 mW.

The SN54180 is characterized for operation over the full military temperature range of -55° C to 125° C; and the SN74180 is characterized for operation from 0° C to 70° C.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, V _{CC} (see Note 1)		 7 V
Input voltage		 5.5 V
Operating free-air temperature range:	: SN54180 Circuits	 25°C
Storage temperature range		 50°C

NOTE 1: Voltage values are with respect to network ground terminal.

recommended operating conditions

		SN54180			SN74180		
	MIN	NOM	MAX	MIN	NOM	MAX	UNIT
Supply voltage, V _{CC}	4.5	5	5.5	4.75	5	5.25	٧
High-level output current, IOH			-800			-800	μA
Low-level output current, IOL			16			16	mA
Operating free-air temperature, TA	-55		125	0		70	°C

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SN54180, SN74180 9-BIT ODD/EVEN PARITY GENERATORS/CHECKERS

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

	PARAMETE	:D	TEST CONDITIONS†		SN54180			SN74180		
FANAMEICK		TEST CONDITIONS.	MIN	TYP‡	MAX	MIN	TYP‡	MAX	UNIT	
V _{IH} High-level input voltage				2			2			V
VIL	Low-level input voltage					8.0			0.8	V
V _{IK} Input clamp voltage			V _{CC} = MIN, I _I = -12 mA	4		-1.5			-1.5	V
V _{OH}	High-level output voltage	9	V _{CC} = MIN, V _{IH} = 2 V, V _{IL} = 0.8 V, I _{OH} = -800	μΑ 2.4	3,3		2.4	3.3		V
VOL	OL Low-level output voltage		V _{CC} = MIN, V _{IH} = 2 V, V _{IL} = 0.8 V, I _{OL} = 16 m	A	0.2	0.4		0.2	0.4	V
կ	Input current at maximum input voltage		$V_{CC} = MAX$, $V_I = 5.5 V$			1			1	mA
1	Any data inpu		VMAX -W24W			40			40	
HI	IIH High-level input current	Even or odd input	V _{CC} = MAX, V _I = 2.4 V			80			80	μΑ
1		Any data input	VMAY V04V			-1.6			-1.6	
IIL Low-level input curr	Low-level input current	Even or odd input	$V_{CC} = MAX, V_{\parallel} = 0.4 V$			-3.2			-3.2	mA
los	IOS Short-circuit output current§		V _{CC} = MAX	-20		-55	-18		-55	mA
Icc	ICC Supply current		V _{CC} = MAX, See Note 2		34	49		34	56	mA

NOTE 2: I_{CC} is measured with even and odd inputs at 4.5 V, all other inputs and outputs open.

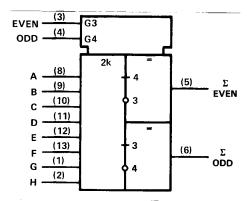
For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions for the applicable type. ‡ All typical values are at V_{CC} = 5 V, T_A = 25°C. § Not more than one output should be shorted at a time.

switching characteristics, $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$

PARAMETER¶	FROM (INPUT)	TO (OUTPUT)	TEST CONDI	MIN	TYP	MAX	UNIT	
^t PLH	Data	Σ Even				40	60	
tPHL		2 Lven	C _L = 15 pF, Odd input grounded,	R _L = 400Ω , See Note 3		45	68	ns
^t PLH	Data	Σ Odd				32	48	ns
tPHL_	Data	2 Odd				25	38	
^t PLH	Data	Σ Even				32	48	
^t PHL	Data	2 LVen	C _L = 15 pF, Even input grounded,	R _L = 400 Ω, , See Note 3		25	38	ns
^t PLH	Data	Σ Odd				40	60	ns
^t PHL	, Data	2 Oud				45	68	
^t PLH	Even or Odd	Σ Even or Σ Odd	CL = 15 pF,	$R_L = 400 \Omega$,		13	20	
^t PHL			See Note 3			7	10	ns

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.

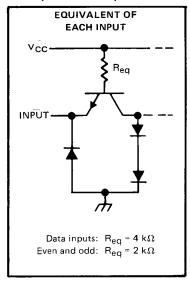
logic symbol†

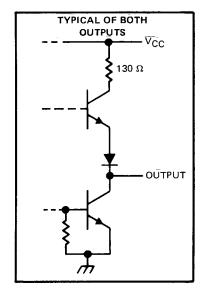


[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

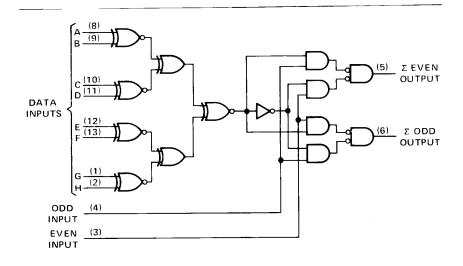


schematics of inputs and outputs





logic diagram (positive logic)



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PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead finish/ Ball material	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
SN54180J	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SN54180J	Samples
SNJ54180J	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54180J	Samples
SNJ54180J	ACTIVE	CDIP	J	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54180J	Samples
SNJ54180W	ACTIVE	CFP	W	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54180W	Samples
SNJ54180W	ACTIVE	CFP	W	14	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SNJ54180W	Samples

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead finish/Ball material Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.



PACKAGE OPTION ADDENDUM

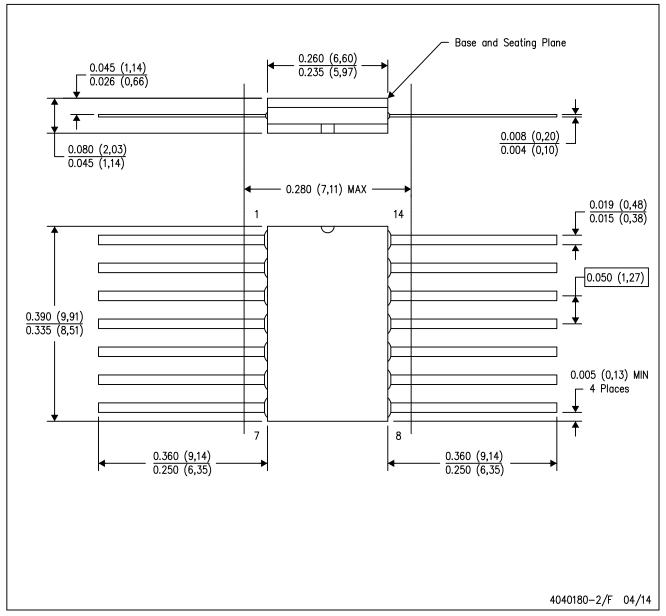
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W (R-GDFP-F14)

CERAMIC DUAL FLATPACK

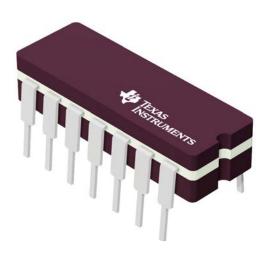


NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only.
- E. Falls within MIL STD 1835 GDFP1-F14



CERAMIC DUAL IN LINE PACKAGE



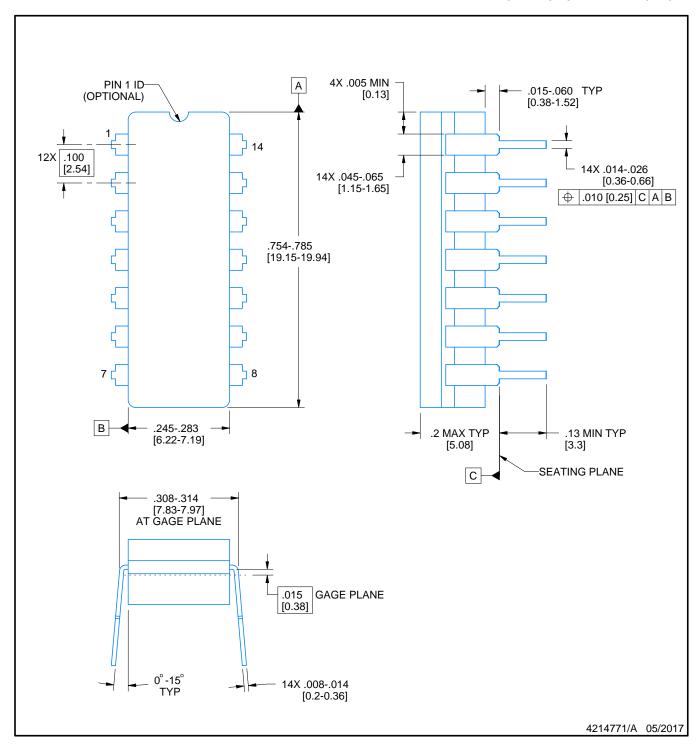
Images above are just a representation of the package family, actual package may vary. Refer to the product data sheet for package details.

4040083-5/G



CDIP - 5.08 mm max height

CERAMIC DUAL IN LINE PACKAGE

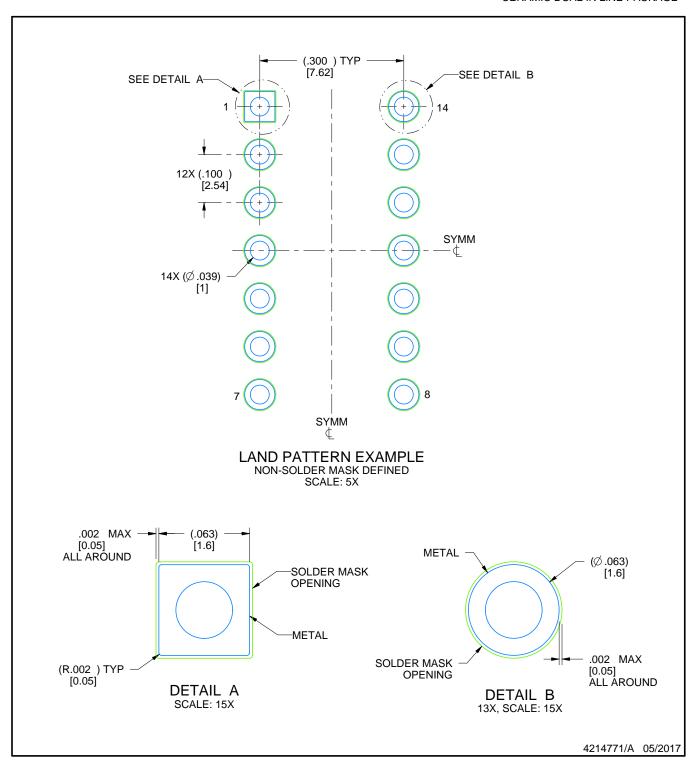


NOTES:

- 1. All controlling linear dimensions are in inches. Dimensions in brackets are in millimeters. Any dimension in brackets or parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
- 2. This drawing is subject to change without notice.
- 3. This package is hermitically sealed with a ceramic lid using glass frit.
- His package is remitted by sealed with a ceramic its using glass mit.
 Index point is provided on cap for terminal identification only and on press ceramic glass frit seal only.
 Falls within MIL-STD-1835 and GDIP1-T14.



CERAMIC DUAL IN LINE PACKAGE





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